

Wire Wound Type Balun

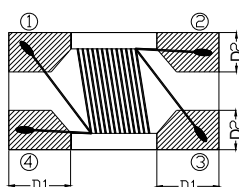
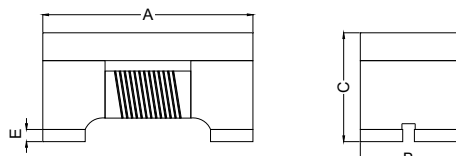
BCM2012F2SF-SERIES

1. Features

1. Low insertion loss at frequency range.
2. BCM2012F2SF series realizes small size and low profile. 2.0x1.2x1.2 mm.
3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
4. Operating temperature -40~+125°C (Including self - temperature rise)



2. Dimension



Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	E(mm)
2012F2SF	2.0±0.2	1.2±0.2	1.2±0.2	0.50±0.1	0.51±0.1	0.15±0.1

3. Part Numbering

BCM	2012	F	2	S	F	-	750	11	-	122
A	B	C	D	E	F		G	H		I

- A: Series
 B: Dimension
 C: Material Ferrite Core
 D: Number of Lines 2=2 lines
 E: Type S=Shielded , N=Unshielded
 F: Lead free
 G: Impedance Match 750= 75 ohm
 H: Turns Rate 11=1 : 1
 I: Control S/N Internal code

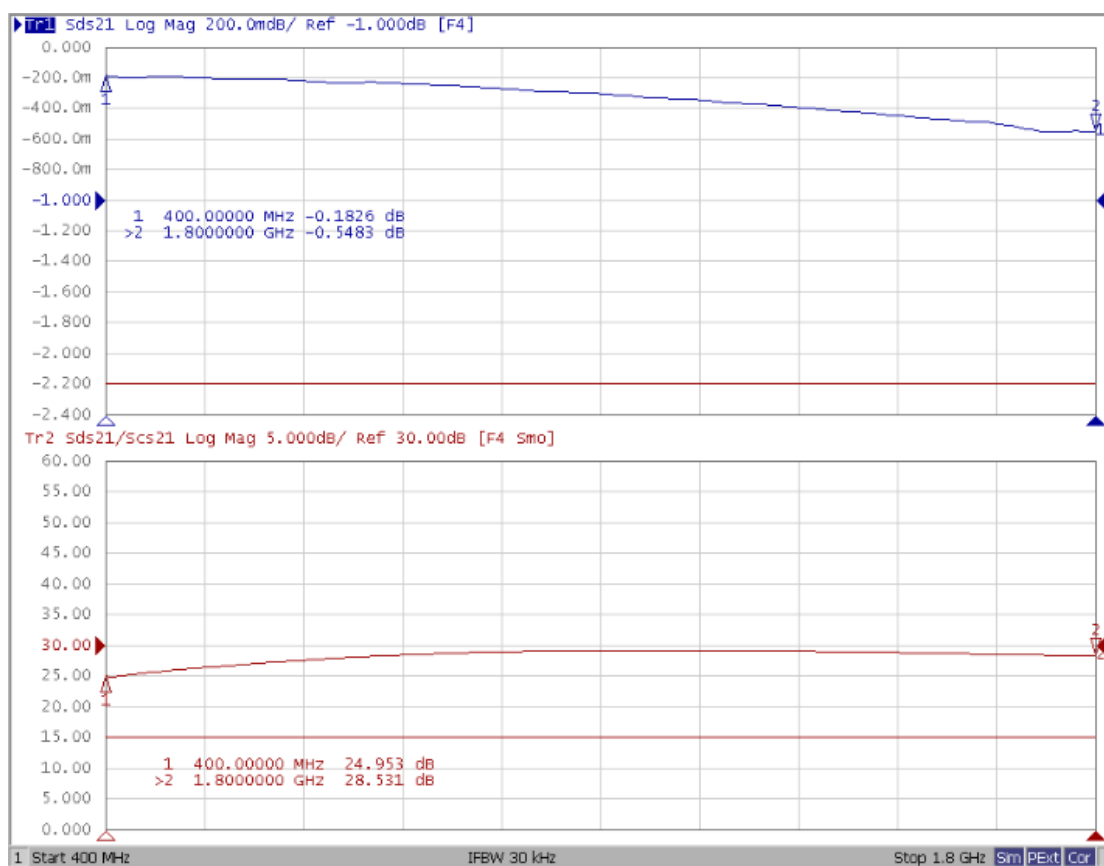
4. Specification

TAI-TECH Part Number	UB/B Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Power (dBm) max.	Rated Volt. (DCV) max.	Withstand Volt. (DCV) max.	IR (MΩ) min.	Insertion Loss (dB)max	CMRR (dB)
BCM2012F2SF-50011-TE2	50/50	400~1800	0.50	27	20	125	10	2.2	15(typ.)
BCM2012F2SF-50011-T02	50/50	40~ 860	1.00	27	20	125	10	2.5	20(typ.)
BCM2012F2SF-50011-MN2	50/50	100~1000	0.35	27	20	50	10	1.0	10(min.)
BCM2012F2SF-50011-ST2	50/50	45~870	1.00	27	20	50	10	1.2	20(min.)
BCM2012F2SF-75011-TE2	75/75	400~1800	0.50	27	20	125	10	2.0	15(typ.)
BCM2012F2SF-75011-T02	75/75	50~1200	0.70	27	20	125	10	1.2	20(typ.)
BCM2012F2SF-75011-MS2	75/75	1000~1500	0.59	27	20	50	10	1.4	20(min.)

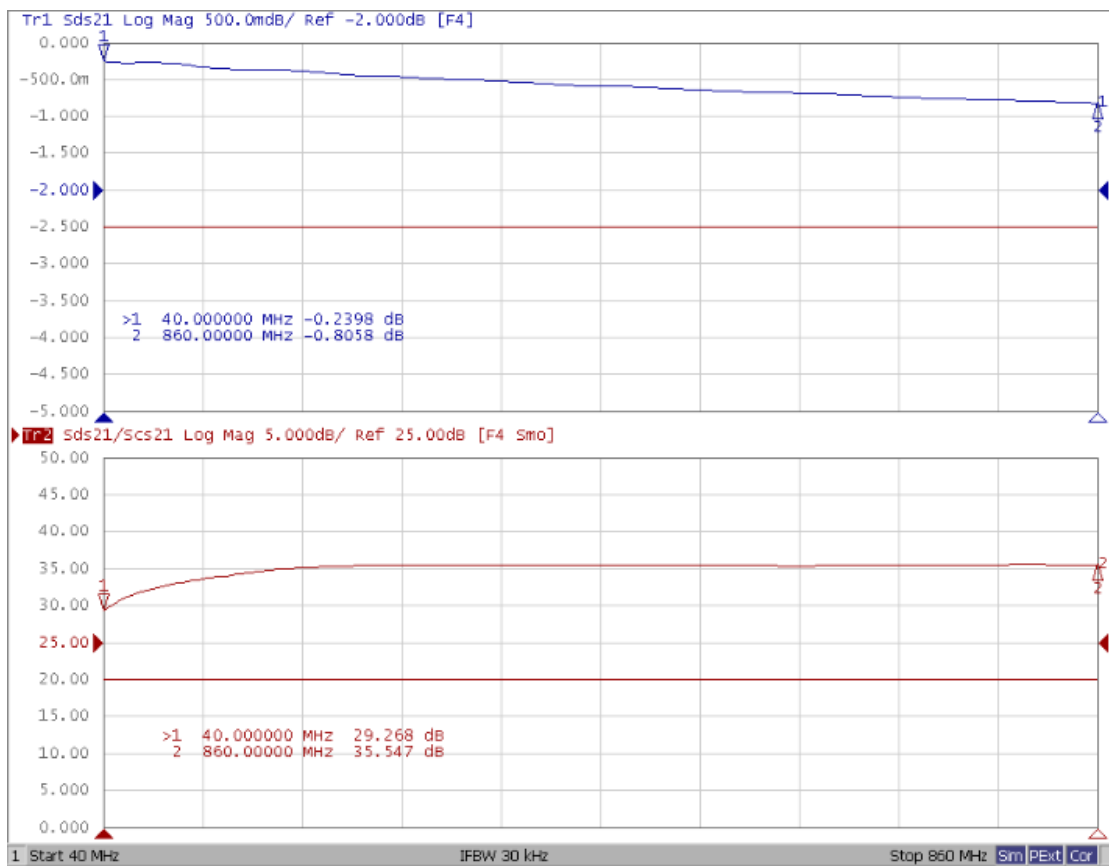
TAI-TECH Part Number	UB/B Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Power (dBm) max.	Rated Volt. (DCV) max.	Withstand Volt. (DCV) max.	IR ($M\Omega$) min.	Insertion Loss (dB)max	CMRR (dB)
BCM2012F2SF-75011-MT2	75/75	50~1200	0.77	27	20	50	10	50~870MHz:1.0 870~1200MHz:1.2.	20(min.)
BCM2012F2SF-75011-SA2	75/75	45~870	0.88	27	20	50	10	1.0	20(min.)
BCM2012F2SF-75011-SB2	75/75	50~1200	0.70	27	20	50	10	1.2	20(min.)
BCM2012F2SF-75011-122	75/75	1000~1500	0.59	27	20	50	10	1.4	20(min.)

Insertion Loss & CMRR

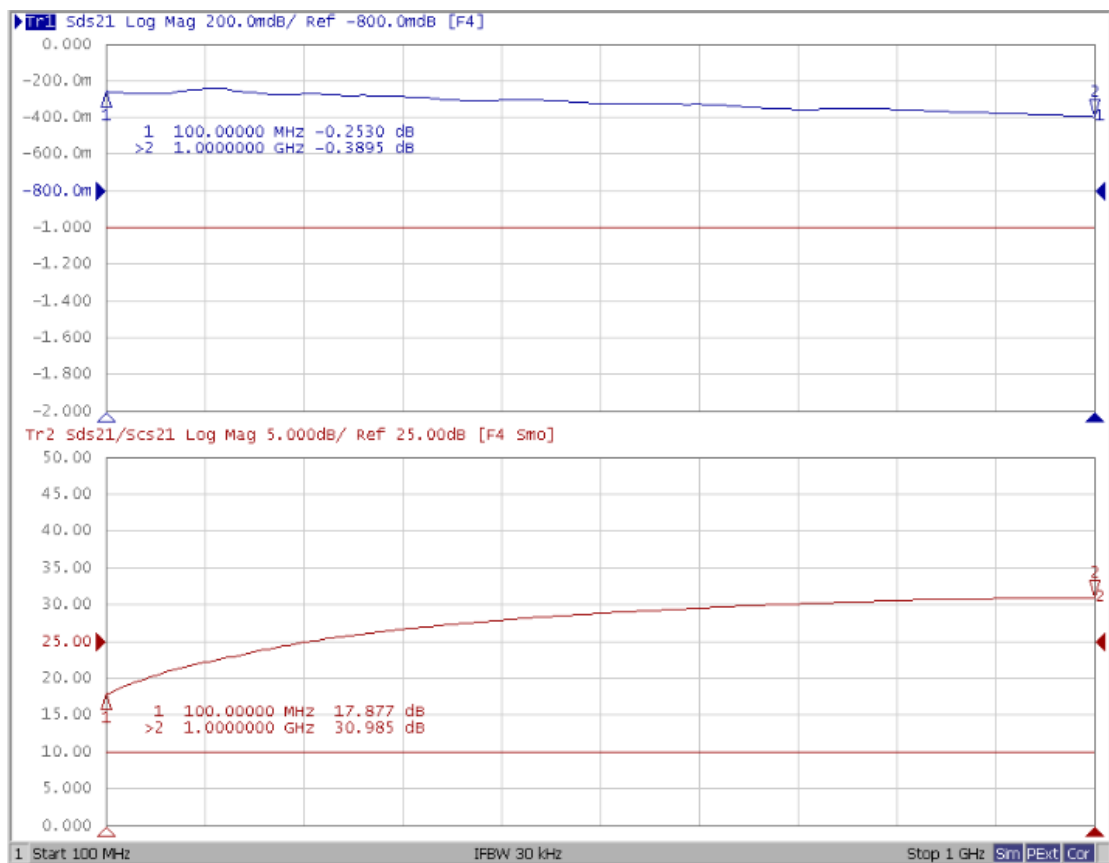
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BCM2012F2SF-50011-T02



BCM2012F2SF-50011-MN2



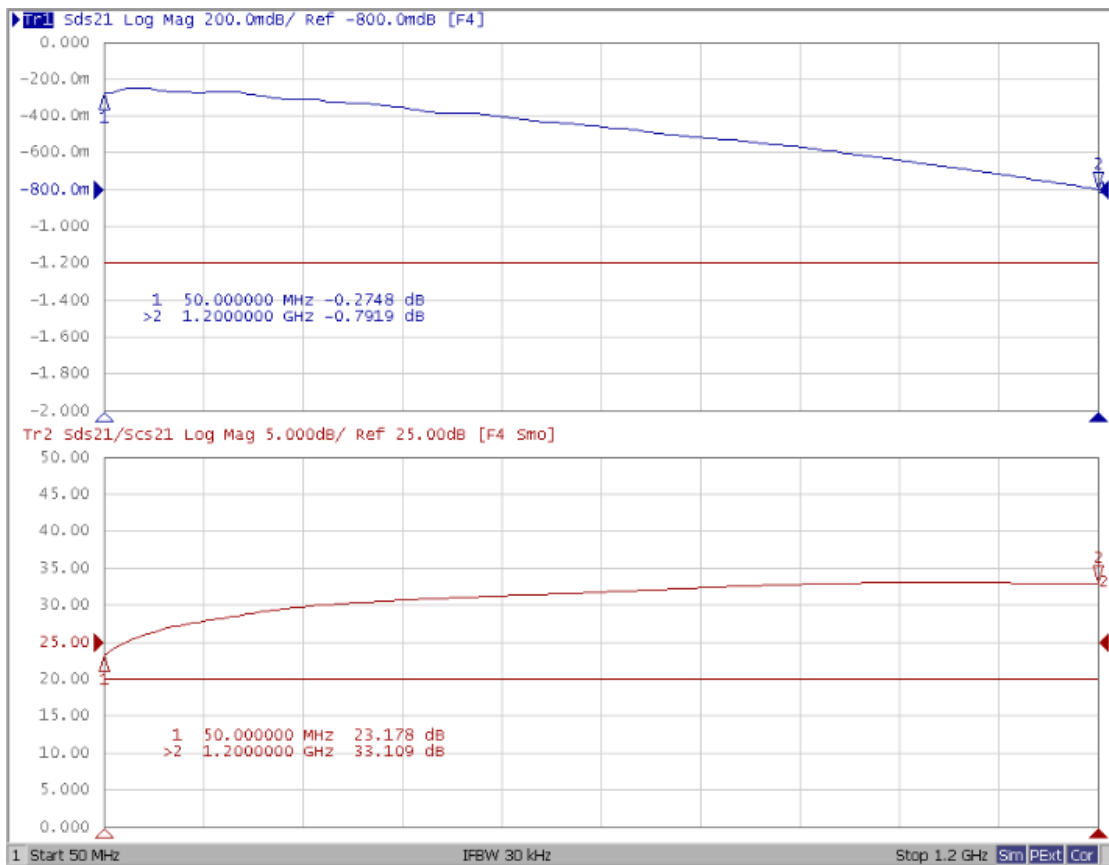
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BCM2012F2SF-75011-TE2



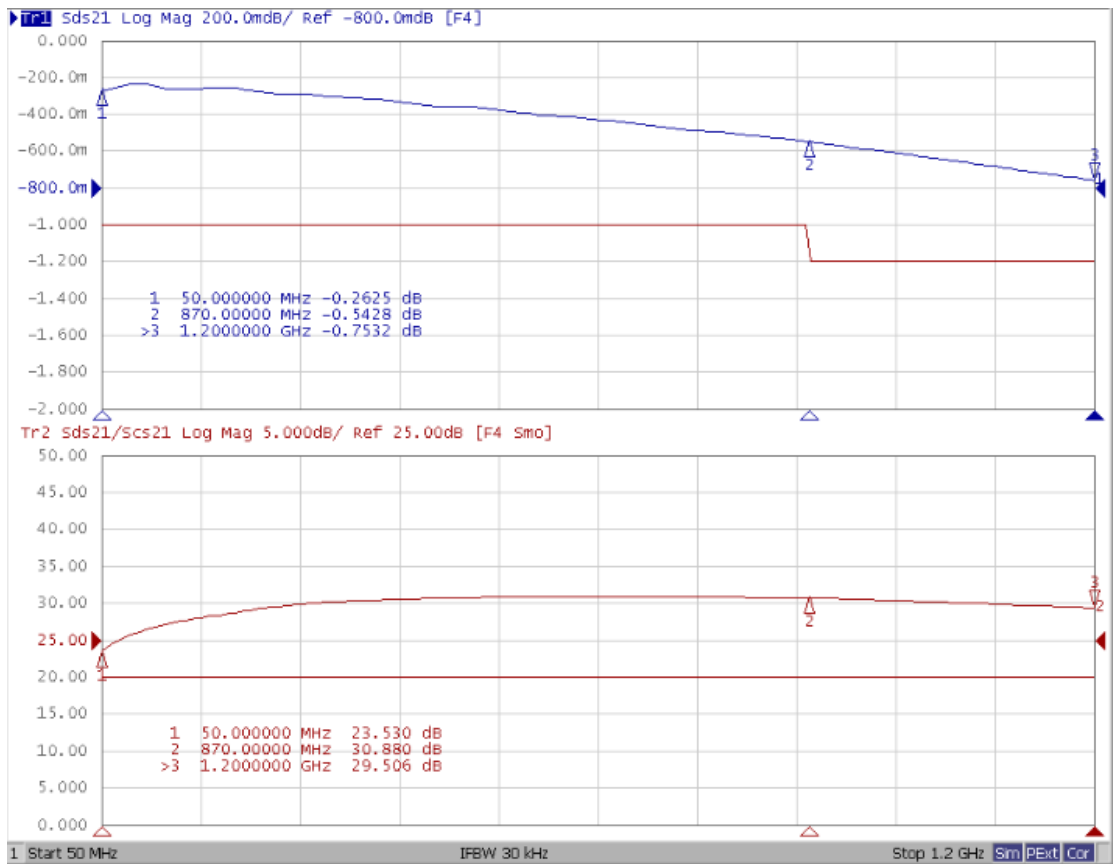
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BCM2012F2SF-75011-MS2



BCM2012F2SF-75011-MT2



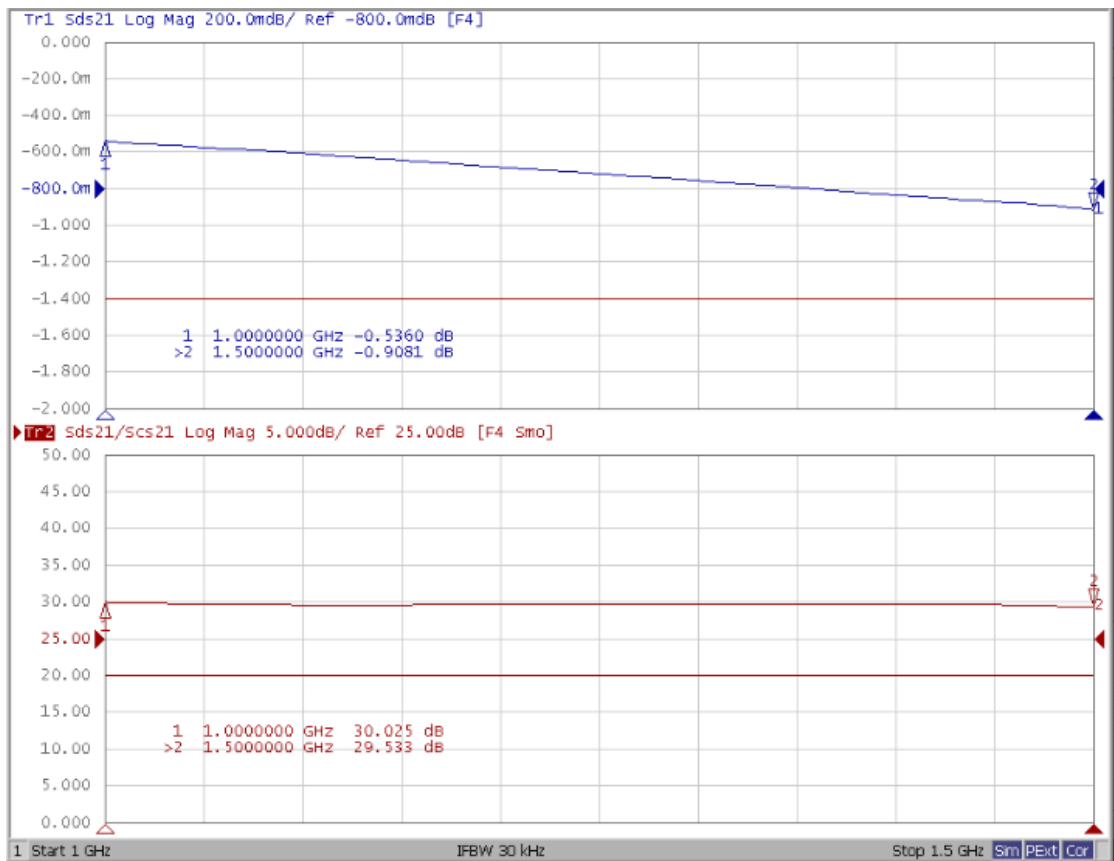
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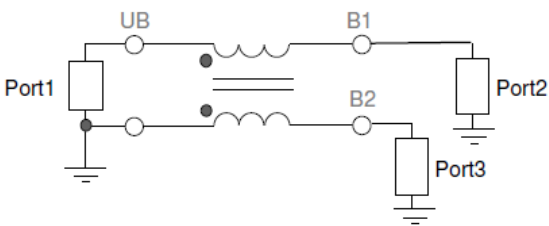
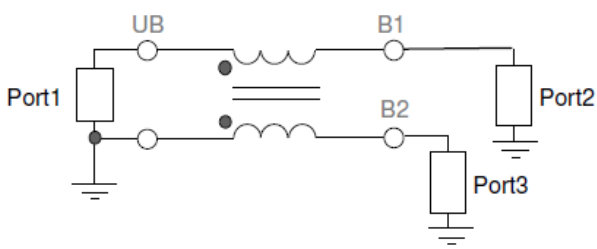


BCM2012F2SF-75011-SB2



BCM2012F2SF-75011-122



ITEM	Definition and Measurement Method
<p>Insertion Loss</p>	<p>Insertion Loss is measured with Vector Network Analyzer (VNA) .</p> <p>Insertion Loss is Sds21 mag extracted from the following circuit. Parasitics and loss factors caused by the test board have to be removed by “De-embedding” computation.</p> <p>$IL[dB] = 20\log_{10}(S_{ds21})$</p> <p>Where</p> <p>Sds21 is S-parameter of single mode stimulus - Differential mode response</p> 
<p>CMRR</p>	<p>Common Mode Rejection Ratio (CMRR) is a function of both amplitude imbalance and phase imbalance. If a differential VNA is not available, CMRR can be computed based on single ended measurement.</p> <p>$CMRR[dB] = 20\log_{10}(S_{ds21}/S_{cs21}) = 20\log_{10}\{(S_{21}+S_{31})/(S_{21}-S_{31})\}$</p> <p>Where</p> <p>Sds21 is S-parameter of single mode stimulus - Differential mode response</p> <p>Scs21 is S-parameter of single mode stimulus - Common mode response</p> <p>Measurement setup for the single ended measurement is as follows. It is assumed that the single-ended S-parameters are obtained with proper matched-load termination at each port. Parasitics and loss factors caused by the test board have to be removed by “De-embedding” computation.</p> 

5. Schematic Diagram

